



1-Bit Bidirectional Voltage-Level Translator for Open-Drain and Push-Pull Application

1 FEATURES

- **No Direction-Control**
- **Data Rates** 24Mbps (Push-Pull) 2Mbps (Open-Drain)
- 1.65V to 5.5V on A ports and 2.3V to 5.5V on B Ports (V_{CCA}≤V_{CCB})
- Vcc Isolation: If Either Vcc is at GND, Both Ports are in the High-Impedance State
- **No Power-Supply Sequencing Required:** Either V_{CCA} or V_{CCB} can be Ramped First
- **IOFF: Supports Partial-Power-Down Mode** Operation
- Extended Temperature: -40°C to +85°C

2 APPLICATIONS

- I²C/SMBus
- UART
- **GPIO**

3 DESCRIPTIONS

This 1-bit non-inverting translator is a bidirectional voltagelevel translator and can be used to establish digital switching compatibility between mixed-voltage systems. It uses two separate configurable power-supply rails, with the A ports supporting operating voltages from 1.65V to 5.5V while it tracks the V_{CCA} supply, and the B ports supporting operating voltages from 2.3V to 5.5V while it tracks the V_{CCB} supply. This allows the support of both lower and higher logic signal levels while providing bidirectional translation capabilities between any of the 1.8V, 2.5V, 3.3V and 5V voltage nodes.

When the output-enable (OE) input is low, all I/Os are placed in the high-impedance state, which significantly reduces the power-supply quiescent current consumption. OE has an internal pull-down current source, as long as VCCA is powered.

To ensure the high-impedance state during power up or power down, OE should be tied to GND through a pulldown resistor: the minimum value of the resistor is determined by the current-sourcing capability of the driver.

The RS0101 is available in Green SOT23-6, SC70-6 and XDFN1.45X1-6 packages. It operates over an ambient temperature range of -40°C to +85°C.

Device Information (1)						
PART NUMBER	PACKAGE	BODY SIZE (NOM)				
RS0101	SOT23-6	2.92mm×1.60mm				
	SC70-6	2.10mm×1.25mm				
	XDFN1.45X1-6	1.45mm×1.00mm				

For all available packages, see the orderable addendum at the end of the data sheet.



4 Functional Block Diagram





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5 Revision History Note: Page numbers for previous revisions may different from page numbers in the current version.

VERSION	Change Date	Change Item
A.1	2020/09/02	Initial version completed
A.2	2020/09/10	Fix mistake in PACKAGE/ORDERING INFORMATION. Order number value from RS0101YUTDV8 to RS0101YUTDV6
A.3	2021/01/09	Add Moisture Sensitivity Level information
A.4	2021/11/01	1.Change Recommended Operating Conditions in Page 6 @ A.3 Version 2.Add TAPE AND REEL INFORMATION 3.Add Typical Characteristics
A.5	2023/07/20	1.Update PACKAGE MARKING on Page 5@RevA.42.Change the Voltage Waveforms Enable and Disable diagram in Page 17@ A.4 Version
A.6	2023/10/30	Update PACKAGE/ORDERING INFORMATION on Page 5@RevA.5
A.6.1	2024/02/23	Modify packaging naming



6 PACKAGE/ORDERING INFORMATION (1)

PRODUCT	ORDERING NUMBER	TEMPERATURE RANGE	PACKAGE LEAD	PACKAGE MARKING	MSL ⁽³⁾	PACKAGE OPTION
	RS0101YH6	-40°C ~+85°C	SOT23-6	0101	MSL3	Tape and Reel,3000
RS0101	RS0101YC6	-40°C ~+85°C	SC70-6 ⁽⁴⁾	0101	MSL3	Tape and Reel,3000
	RS0101YUTDV6	-40°C ~+85°C	XDFN1.45X1-6	101	MSL3	Tape and Reel,3000

NOTE:

(1) This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the right-hand navigation.

(2) There may be additional marking, which relates to the lot trace code information(data code and vendor code), the logo or the environmental category on the device.

(3) MSL, The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications.

(4) Equivalent to SOT363.

Marking Information

(1) SOT23-6, SC70-6



(2) XDFN1.45X1-6





7 PIN CONFIGURATIONS



PIN DESCRIPTION

PI	N	NAME	TYPE ⁽¹⁾	FUNCTION
SOT23-6/SC70-6	XDFN1.45X1-6	INAME	ITPE/	FUNCTION
1	6	Vcca	Ρ	A Port Supply Voltage.1.65V \leq V _{CCA} \leq 5.5V and V _{CCA} \leq V _{CCB} .
2	5	GND	I	Ground.
3	4	А	I/O	Input/output A. Reference to V _{CCA} .
4	3	В	I/O	Input/output B. Reference to V _{CCB} .
5	2	OE	Ι	Output Enable (Active High). Pull OE low to place all outputs in 3-state mode. Referenced to V _{CCA} .
6	1	V _{CCB}	Р	B Ports Supply Voltage.2.3V \leq V _{CCB} \leq 5.5V.

(1) I=input, O=output, I/O=input and output, P=power



8 SPECIFICATIONS

8.1 Absolute Maximum Ratings

Over operating free-air temperature range (unless otherwise noted)⁽¹⁾

SYMBOL	PARAMETER		MIN	MAX	UNIT
Vcca	Supply Voltage Range		-0.3	6.0	V
Vccb	Supply Voltage Range		-0.3	6.0	V
VI ⁽²⁾	Input Voltage Dange	A port	-0.3	6.0	v
VI ⁽⁻⁾	Vi ⁽²⁾ Input Voltage Range	B port	-0.3	6.0	V
Vo ⁽²⁾	Voltage range applied to any output in the high- impedance or power-off state	A port	-0.3	6.0	V
VO ⁽⁼⁾		B port	-0.3	6.0	V
Vo ⁽²⁾⁽³⁾	Voltage range applied to any output in the high or	A port	-0.3	V _{CCA} +0.3	
VO	Voltage range applied to any output in the high or low state	B port	-0.3	V _{CCB} +0.3	V
I _{IK}	Input clamp current	V1<0		-50	mA
loк	Output clamp current	Vo<0		-50	mA
lo	Continuous output current			±50	mA
	Continuous current through V _{CCA} , V _{CCB} or GND			±100	mA
۲J	Junction Temperature ⁽⁴⁾		-40	150	°C
T_{stg}	Storage temperature		-65	+150	

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

(3) The value of V_{CCA} and V_{CCB} are provided in the recommended operating conditions table.

(4) The maximum power dissipation is a function of $T_{J(MAX)}$, R_{JA} , and T_A . The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(MAX)} - T_A) / R_{0JA}$. All numbers apply for packages soldered directly onto a PCB.

8.2 ESD Ratings

The following ESD information is provided for handling of ESD-sensitive devices in an ESD protected area only.

			VALUE	UNIT
	V _(ESD) Electrostatic discharge	Human-body model (HBM)	±5000	V
V (ESD)		machine model (MM)	±400	V



ESD SENSITIVITY CAUTION

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.



8.3 Recommended Operating Conditions

V_{CCI} is the supply voltage associated with the input port. V_{CCO} is the supply voltage associated with the output port.

PARAMETER	(CONDITIONS	MIN	ТҮР	MAX	UNIT
Supply voltage ⁽¹⁾	V _{CCA}		1.65		5.5	v
Supply voltage	V _{CCB}		2.3		5.5	v
	A-port I/Os	V _{CCA} = 1.65 V to 1.95 V V _{CCB} = 2.3 V to 5.5 V	V _{CCI} – 0.2		Vcci	V
High-level input voltage	A-port 1/Os	V _{CCA} = 2.3 V to 5.5 V V _{CCB} = 2.3 V to 5.5 V	V _{CCI} – 0.4		Vcci	V
(V _{IH})	B-port I/Os	V _{CCA} = 1.65 V to 5.5 V V _{CCB} = 2.3 V to 5.5 V	V _{CCI} – 0.4		V _{CCI}	V
	OE input	V _{CCA} = 1.65 V to 5.5 V V _{CCB} = 2.3 V to 5.5 V	$V_{CCA} \times 0.8$		5.5	V
	A-port I/Os	V _{CCA} = 1.65 V to 5.5 V V _{CCB} = 2.3 V to 5.5 V	0		0.15	V
Low-level input voltage (V _{IL})	B-port I/Os	V _{CCA} = 1.65 V to 5.5 V V _{CCB} = 2.3 V to 5.5 V	0		0.15	V
	OE input	V _{CCA} = 1.65 V to 5.5 V V _{CCB} = 2.3 V to 5.5 V	0		V _{CCA} ×0.25	V
Input transition rise or fall rate($\Delta t / \Delta v$)		A-port I/Os push-pull driving			10	ns/V
		B-port I/Os push-pull driving			10	ns/V
		Control input			10	ns/V
T _A Operating free-air tem	perature		-40		85	°C

(1) V_{CCA} must be less than or equal to V_{CCB} .

(2) The maximum V_{L} value is provided to ensure that a valid V_{OL} is maintained. The V_{OL} value is V_{L} plus the voltage drop across the pass gate transistor.



8.4 Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted) $^{(1)(2)(3)}$

PA	RAMETER	CONDITIONS	Vcca	Vссв	TEMP	MIN ⁽⁴⁾	TYP ⁽⁵⁾	MAX ⁽⁴⁾	UNIT	
Vона	Port A output high voltage	I _{OH} = −20 μA V _{IB} ≥ V _{CCB} − 0.4V	1.65V to 5.5V	2.3V to 5.5V	Full	V _{CCA} × 0.7		5.5		
Vola	Port A output low voltage	I _{OL} = 1mA V _{IB} ≤ 0.15 V	1.65V to 5.5V	2.3V to 5.5V	Full			0.3	v	
V _{OHB}	Port B output high voltage	I _{OH} = −20 μA V _{IA} ≥ V _{CCA} − 0.4 V	1.65V to 5.5V	2.3V to 5.5V	Full	V _{ссв} × 0.7			v	
Volb	Port B output low voltage	I _{OL} = 1mA V _{IA} ≤ 0.15 V	1.65V to 5.5V	2.3V to 5.5V	Full			0.3		
h	Input leakage	OE	1.65V to 5.5V	2.3V to 5.5V	+25°C			±0.5	μA	
	current				Full			±1.5	P	
		A Ports	οv	0V to 5.5V	+25°C			±0.5	μA	
l _{off}	Partial power I _{off} down	A POILS		00 10 5.50	Full			±1		
1011	current	B Ports	0V to 5.5V	OV	+25°C			±0.5	μA	
		BTORS	00000		Full			±1	μΛ	
	High- impedance State output current	A or B port			+25°C			±0.5		
loz ⁽⁶⁾		OE=0V	1.65V to 5.5V	2.3V to 5.5V	Full			±1	μA	
			1.65V to V_{CCB}	2.3V to 5.5V	Full			2.5		
Icca	V _{CCA} supply current			5.5V	0V	Full			2.5	μA
	current	10 - 0	0V	5.5V	Full			-1	μΛ	
			1.65V to V _{CCB}	2.3V to 5.5V	Full			10		
Іссв	V _{CCB} supply current	$V_1 = V_0 = open$ $I_0 = 0$	5.5V	0V	Full			-1	μA	
	current	10 - 0	0V	5.5V	Full			1		
Ісса + Іссв	Combined supply current	$V_I = V_O = open$ $I_O = 0$	1.65V to V _{CCB}	2.3V to 5.5V	Full			11	μA	
Iccza	V _{CCA} supply current	$V_I = V_{CCI} \text{ or } 0V$ $I_0 = 0, OE=0V$	1.65V to V _{CCB}	2.3V to 5.5V	Full			1	μA	
Ісств	V _{CCB} supply current	$V_{I} = V_{CCI} \text{ or } 0V$ $I_{O} = 0, OE=0V$	2.3V to 5.5V	2.3V to 5.5V	Full			1	μA	
CI	Input capacitance	OE	3.3V	3.3V	+25°C		2.5		pF	
	Input-to-	A port	3.3V	3.3V	+25°C		5			
CIO	output internal capacitance	B port	3.3V	3.3V	+25°C		5		pF	

(1) V_{CCI} is the V_{CC} associated with the input port.

(2) V_{CCO} is the V_{CC} associated with the output port

(3) V_{CCA} must be less than or equal to V_{CCB} .

(4) Limits are 100% production tested at 25°C. Limits over the operating temperature range are ensured through correlations using statistical quality control (SQC) method.

(5) Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration.

(6) For I/O ports, the parameter I_{OZ} includes the input leakage current.



8.5 Timing Requirements

8.5.1 V_{CCA}=1.8V±0.15 V

		V _{CCB} =2.5V ±0.2V	V _{CCB} =3.3V ±0.2V	V _{CCB} =5V ±0.2V	UNIT	
		ТҮР	ТҮР	ТҮР	UNIT	
Data rata	Push-pull driving	21	22	24	N 4 la va a	
Data rate	Open-drain driving	2	2	2	Mbps	
Pulse duration(t _w)	Push-pull driving (data inputs)	47	45	41	20	
	Open-drain driving (data inputs)	500	500	500	ns	

8.5.2 V_{CCA}=2.5V±0.15 V

		V _{CCB} =2.5V ±0.2V	V _{CCB} =3.3V ±0.2V	V _{CCB} =5V ±0.2V		
		ТҮР	ТҮР	ТҮР	UNIT	
Dete rete	Push-pull driving	20	22	24	Mana	
Data rate	Open-drain driving	2	2	2	Mbps	
Pulse	Push-pull driving (data inputs)	50	45	41		
duration(t _w)	Open-drain driving (data inputs)	500	500	500	ns	

8.5.3 V_{CCA}=3.3V±0.15 V

		V _{CCB} =3.3V ±0.2V	V _{CCB} =5V ±0.2V	UNIT
		ТҮР	ТҮР	UNIT
Data rata	Push-pull driving	23	24	Mhaa
Data rate	Open-drain driving	2	2	Mbps
Pulse	Push-pull driving (data inputs)	43	41	
duration(t _w)	Open-drain driving (data inputs)	500	500	ns

8.5.4 V_{CCA}=5V±0.15 V

		V _{CCB} =5V ±0.2V	UNIT
		ТҮР	UNIT
Data vata	Push-pull driving	24	Mhaa
Data rate	Open-drain driving	2	Mbps
Pulse	Push-pull driving (data inputs)	41	
duration(t _w)	Open-drain driving (data inputs)	500	ns



8.6 Switching Characteristics: V_{CCA}=1.8V ± 0.15V over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		CONDITIONS		V _{CCB} =2.5V±0.2V	V _{CCB} =3.3V±0.2V	V _{CCB} =5V±0.2V		
PA	RAMETER		CONDITIONS	ТҮР	ТҮР	ТҮР	UNIT	
t _{PHL}	Propagation delay time	A-to-B	Push-pull driving	2.5	3.1	4.5	ns	
	high-to-low output		Open-drain driving	26.1	26.4	26.6		
t _{PLH}	Propagation delay time	A-to-B	Push-pull driving	4.2	3.7	3.6	ns	
	low-to-high output		Open-drain driving	221	183	143		
tрнL	Propagation delay time	B-to-A	Push-pull driving	2.1	2.0	2.2	ns	
	high-to-low		Open-drain driving	26.1	26.1	26.2	-	
	t _{PLH} Propagation delay time low-to-high output		Push-pull driving	1.8	1.6	1.5	ns	
tplh		B-to-A	Open-drain driving	173	89	66		
t _{en}	Enable time	OE-to-A d	or B	25	21	19	ns	
t_{dis}	Disable time	OE-to-A o	or B	1250	1250	1250	ns	
t _{rA}	Input rise	A port	Push-pull driving	6.9	6.1	5.6	nc	
LrA	time	rise time	Open-drain driving	118	39	13	ns	
t _{rB}	Input rise	B port	Push-pull driving	5.8	4.8	4.1	ns	
чв	time	rise time	Open-drain driving	166	127	75	115	
t _{fA}	Input fall	A port	Push-pull driving	3.0	2.8	2.7	ns	
LĮĄ	time	fall time	Open-drain driving	1.9	1.7	1.6	115	
t _{fB}	Input fall	B port	Push-pull driving	4.8	6.2	8.4	nc	
LtB	time fall time		Open-drain driving	2.3	2.4	2.8	ns	
tsk(o)	Skew(time), output	Channel-to-Channel Skew		0.5	0.5	0.5	ns	
Master	um data rata	Push-pull	driving	21	22	24	Mhaa	
maxim	ium data rata	Open-dra	in driving	2	2	2	Mbps	



8.7 Switching Characteristics: V_{CCA}=2.5V ± 0.15V over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		CONDITIONS		V _{CCB} =2.5V±0.2V	V _{CCB} =3.3V±0.2V	V _{CCB} =5V±0.2V	UNIT	
PA	RAMETER		ONDITIONS	ТҮР	ТҮР	ТҮР	UNIT	
tphl	Propagation delay time	A-to-B	1 0		3.4	5.0	ns	
UPHL	high-to-low output		Open-drain driving	26.3	26.5	26.6	115	
tplh	Propagation delay time	A-to-B	Push-pull driving	2.7	2.5	2.4	ns	
LPLH	^{TPLH} low-to-high output	A-10-D	Open-drain driving	198	169	131	115	
tphl	Propagation delay time	B-to-A	Push-pull driving	2.5	2.4	2.5	ns	
LPHL	^{TPHL} high-to-low output	D-10-A	Open-drain driving	26.4	26.5	26.6	115	
touu	Propagation delay time low-to-high output	B-to-A	Push-pull driving	2.1	2.0	1.9	ns	
LPLH		D-10-A	Open-drain driving	196	138	63		
t_{en}	Enable time	OE-to-A o	or B	24	20	17	ns	
t_{dis}	Disable time	OE-to-A o	or B	1250	1250	1250	ns	
4 .	Input rise	A port	Push-pull driving	3.4	2.9	2.7		
t _r A	time	rise time	Open-drain driving	156	92	13	ns	
L.	Input rise	B port	Push-pull driving	4.7	3.5	2.7		
t _{rB}	time	rise time	Open-drain driving	160	124	81	ns	
+	Input fall	A port	Push-pull driving	5.1	5.2	5.0		
t _{fA}	time	fall time	Open-drain driving	2.1	2.0	1.8	ns	
t	Input fall t _{fB} time	B port	Push-pull driving	5.0	6.4	8.7		
LtB		fall time	Open-drain driving	2.0	2.2	2.8	ns	
t _{sk(O)}	Skew(time), output	Channel-to-channel skew		0.5	0.5	0.5	ns	
Maxim	num data rata	Push-pull	driving	20	22	24	Mhne	
IMAXIII	iuni uala falà	Open-dra	in driving	2	2	2	Mbps	



8.8 Switching Characteristics: V_{CCA}=**3.3V** ± **0.3V** over recommended operating free-air temperature range (unless otherwise noted)

DADAMETER		CONDITIONS		V _{CCB} =3.3V±0.2V	V _{CCB} =5V±0.2V		
PARAMETER			CONDITIONS	ТҮР	ТҮР	UNIT	
	Propagation		Push-pull driving	3.6	5.1		
tphl	delay time high-to-low output	A-to-B	Open-drain driving	26.4	26.6	ns	
	Propagation		Push-pull driving	2.3	2.1		
tplh	delay time low-to-high output	A-to-B	Open-drain driving	155	109	ns	
	Propagation		Push-pull driving	3.1	3.3		
tphl	delay time high-to-low output	B-to-A	Open-drain driving	26.5	26.7	ns	
	Propagation		Push-pull driving	1.9	1.8		
tplh	delay time low-to-high output	B-to-A	Open-drain driving	158	87	ns	
t _{en}	Enable time	OE-to-A or B	OE-to-A or B		15	ns	
t_{dis}	Disable time	OE-to-A or B		1250	1250	ns	
+ .	In must vice times	A port rise	Push-pull driving	2.3	2.1	ns	
t _{rA}	Input rise time	time	Open-drain driving	117	48		
t _{rB}	Input rise time	B port rise	Push-pull driving	3.0	2.4	ns	
ιrΒ	input fise time	time	Open-drain driving	117	75	115	
t _{fA}	Input fall time	A port fall	Push-pull driving	8.0	7.6	nc	
LfA	input fail time	time	Open-drain driving	2.2	2.1	ns	
+	Input fall time	B port fall	Push-pull driving	8.2	10.8	nc	
t _{fB}	input fail time	time	Open-drain driving	2.1	2.4	ns	
tsk(o)	Skew(time), output	Channel-to-channel skew		0.5	0.5	ns	
Maxim	um data rata	Push-pull drivi	ng	23	24	Mbps	
	uni uala lala	Open-drain dr	iving	2	2	14inh2	



8.9 Switching Characteristics: V_{CCA}=5.0V ± 0.35V over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		CONDITIONS		V _{CCB} =5V±0.2V		
			CONDITIONS	ТҮР	UNIT	
tphl	Propagation delay time	A-to-B	Push-pull driving	5.6	ns	
CFTIL	high-to-low output		Open-drain driving	26.8	115	
tplh	Propagation delay time	A-to-B	Push-pull driving	2.0	ns	
UPLH	low-to-high output		Open-drain driving	155	115	
tphl	Propagation delay time	B-to-A	Push-pull driving	5.8		
LPHL	high-to-low output	B-10-A	Open-drain driving	27.5	ns	
tplh	Propagation delay time	B-to-A	Push-pull driving	1.8	ns	
LPLH	low-to-high output	B-IO-A	Open-drain driving	160	115	
t_{en}	Enable time	OE-to-A or B	OE-to-A or B		ns	
t_{dis}	Disable time	OE-to-A or B		1250	ns	
trA	Input rise time	A port rise time	Push-pull driving	1.9	ns	
L rA	input fise time	A port rise time	Open-drain driving	105	115	
+ -	Input rise time	B port rise time	Push-pull driving	2.3	nc	
t _{rB}	input fise time	b port lise time	Open-drain driving	95	ns	
t _{fA}	Input fall time	A port fall time	Push-pull driving	9.0	ns	
цА	input fail time	A port fail time	Open-drain driving	2.6	115	
t _{fB}	Input fall time	B port fall time	Push-pull driving	8.9	ns	
чв	input fail time	D port fair time	Open-drain driving	2.5	115	
tsk(o)	Skew(time), output	Channel-to-chan	Channel-to-channel skew		ns	
		Push-pull driving		24		
Maximum	n data rata	Open-drain drivir	Ig	2	Mbps	



8.10 Typical Characteristics

NOTE: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only.







Figure3: Low-Level Output Voltage vs Low-Level Current





Figure2: Low-Level Output Voltage vs Low-Level Current



Figure4: Low-Level Output Voltage vs Low-Level Current



Figure6: Low-Level Output Voltage vs Low-Level Current



Typical Characteristics

NOTE: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only.







Figure9: Low-Level Output Voltage vs Low-Level Current







Figure8: Low-Level Output Voltage vs Low-Level Current



Figure 10: Low-Level Output Voltage vs Low-Level Current



Figure 12: Low-Level Output Voltage vs Low-Level Current



Typical Characteristics

NOTE: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only.



Figure13: Low-Level Output Voltage vs Low-Level Current



Figure 15: Low-level Output Voltage vs Low-Level Current



Figure14: Low-Level Output Voltage vs Low-Level Current



9 Parameter Measurement Information

Unless otherwise noted, all input pulses are supplied by generators having the following characteristics:

- PRR 10 MHz
- Zo = 50 Ω
- dv/dt ≥ 1 V/ns

Note: All input pulses are measured one at a time, with one transition per measurement.



Figure 16. Data Rate, Pulse Duration, Propagation Delay, Output Rise And Fall Time Measurement Using A Push-Pull Driver



Figure 17. Data Rate, Pulse Duration, Propagation Delay, Output Rise And Fall Time Measurement Using An Open-Drain Driver



Figure 18. Load Circuit for Enable/Disable Time Measurement

TEST	S1
$t_{PZL}^{(1)}, t_{PLZ}^{(2)}$	2 × V _{cco}
t _{PHZL} ⁽¹⁾ , t _{PZH} ⁽²⁾	Open

(1) t_{PZL} and t_{PZH} are the same as t_{en} .

(2) $t_{\mbox{\tiny PLZ}} \, \mbox{and} \, t_{\mbox{\tiny PHZ}} \, \mbox{are the same as } t_{\mbox{\tiny dis}}.$





(1) All input pulses are measured one at a time, with one transition per measurement.

Figure 19. Voltage Waveforms Pulse Duration







A. Waveform 1 is for an output with internal such that the output is high, except when OE is high.B. Waveform 2 is for an output with conditions such that the output is low, except when OE is high.

Figure 21. Voltage Waveforms Enable And Disable



10 Feature Description

10.1 Overview

The RS0101 device is a directionless voltage-level translator specifically designed for translating logic voltage levels. The A port is able to accept I/O voltages ranging from 1.65 V to 5.5 V, while the B port can accept I/O voltages from 2.3 V to 5.5 V. The device is a pass-gate architecture with edge-rate accelerators (one-shots) to improve the overall data rate. 10-k Ω pullup resistors, commonly used in open-drain applications, have been conveniently integrated so that an external resistor is not needed. While this device is designed for open-drain applications, the device can also translate push-pull CMOS logic outputs.

10.2 Architecture

The RS0101 architecture (see Figure 22) is an auto-direction-sensing based translator that does not require a direction-control signal to control the direction of data flow from A to B or from B to A. These two bidirectional channels independently determine the direction of data flow without a direction-control signal. Each I/O pin can be automatically reconfigured as either an input or an output, which is how this auto-direction feature is realized.



Figure 22. Architecture of a RS0101 Cell

The RS0101 employs two key circuits to enable this voltage translation:

1) An N-channel pass-gate transistor topology that ties the A-port to the B-port

2) Output one-shot (O.S.) edge-rate accelerator circuitry to detect and accelerate rising edges on the A or B Ports.

10.3 Input Driver Requirements

The continuous dc-current "sinking" capability is determined by the external system-level open-drain (or push pull) drivers that are interfaced to the RS0101 I/O pins. Since the high bandwidth of these bidirectional I/O circuits is used to facilitate this fast change from an input to an output and an output to an input, they have a modest dc-current "sourcing" capability of hundreds of micro-Amps, as determined by the internal 10-k Ω pullup resistors.

The fall time (t_{fA} , t_{fB}) of a signal depends on the edge-rate and output impedance of the external device driving RS0101 data I/Os, as well as the capacitive loading on the data lines.

Similarly, the t_{PHL} and max data rates also depend on the output impedance of the external driver. The values for t_{fA} , t_{fB} , t_{PHL} , and maximum data rates in the data sheet assume that the output impedance of the external driver is less than 50 Ω .



Feature Description

10.4 Output Load Considerations

We recommend careful PCB layout practices with short PCB trace lengths to avoid excessive capacitive loading and to ensure that proper O.S. triggering takes place. PCB signal trace-lengths should be kept short enough such that the round-trip delay of any reflection is less than the one-shot duration. This improves signal integrity by ensuring that any reflection sees a low impedance at the driver. The O.S. circuits have been designed to stay on for approximately 30 ns. The maximum capacitance of the lumped load that can be driven also depends directly on the one-shot duration. With very heavy capacitive loads, the one-shot can time-out before the signal is driven fully to the positive rail. The O.S. duration has been set to best optimize trade-offs between dynamic ICC, load driving capability, and maximum bit-rate considerations. Both PCB trace length and connectors add to the capacitance that the RS0101 device output sees, so it is recommended that this lumped-load capacitance be considered to avoid O.S. retriggering, bus contention, output signal oscillations, or other adverse system-level affects.

10.5 Enable and Disable

The RS0101 device has an OE input that is used to disable the device by setting OE low, which places all I/Os in the Hi-Z state. The disable time (t_{dis}) indicates the delay between the time when OE goes low and when the outputs are disabled (Hi-Z). The enable time (t_{en}) indicates the amount of time the user must allow for the one-shot circuitry to become operational after OE is taken high.

10.6 Pullup or Pulldown Resistors on I/O Lines

Each A-port I/O has an internal $10-k\Omega$ pullup resistor to V_{CCA}, and each B-port I/O has an internal $10-k\Omega$ pullup resistor to V_{CCB}. If a smaller value of pullup resistor is required, an external resistor must be added from the I/O to V_{CCA} or V_{CCB} (in parallel with the internal $10-k\Omega$ resistors). Adding lower value pull-up resistors will affect V_{OL} levels, however. The internal pull-ups of the RS0101 are disabled when the OE pin is low.



11 Application and Implementation

Information in the following applications sections is not part of the RUNIC component specification, and RUNIC does not warrant its accuracy or completeness. RUNIC's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

11.1 Application Information

The RS0101 device can be used to bridge the digital-switching compatibility gap between two voltage nodes to successfully interface logic threshold levels found in electronic systems. It should be used in a point-to-point topology for interfacing devices or systems operating at different interface voltages with one another. Its primary target application use is for interfacing with open-drain drivers on the data I/Os such as I₂C or 1-wire, where the data is bidirectional and no control signal is available. The device can also be used in applications where a push-pull driver is connected to the data I/Os, but the RS0101 might be a better option for such push-pull applications.

11.2 Typical Application



Figure 23. Typical Application Circuit

12 PACKAGE OUTLINE DIMENSIONS SOT23-6⁽³⁾





RECOMMENDED LAND PATTERN (Unit: mm)





Sumb al	Dimensions I	n Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Мах	
A ⁽¹⁾	1.050	1.050 1.250		0.049	
A1	0.000	0.100	0.000	0.004	
A2	1.050	1.150	0.041	0.045	
b	0.300	0.500	0.012	0.020	
с	0.100	0.200	0.004	0.008	
D ⁽¹⁾	2.820	3.020	0.111	0.119	
E ⁽¹⁾	1.500	1.700	0.059	0.067	
E1	2.650	2.950	0.104	0.116	
e	0.950(0.950(BSC) ⁽²⁾		BSC) ⁽²⁾	
e1	1.800	2.000	0.071	0.079	
L	0.300	0.600	0.012	0.024	
θ	0 °	8 <i>°</i>	0 <i>°</i>	8 <i>°</i>	

NOTE:

1. Plastic or metal protrusions of 0.15mm maximum per side are not included.

2. BSC (Basic Spacing between Centers), "Basic" spacing is nominal.

3. This drawing is subject to change without notice.



SC70-6⁽³⁾





RECOMMENDED LAND PATTERN (Unit: mm)





Symphol	Dimensions I	n Millimeters	Dimensions In Inches			
Symbol	Min	Max	Min	Max		
A ⁽¹⁾	0.900	1.100	0.035	0.043		
A1	0.000	0.100	0.000	0.004		
A2	0.900	1.000	0.035	0.039		
b	0.150	0.350	0.006	0.014		
с	0.080	0.150	0.003	0.006		
D ⁽¹⁾	2.000	2.200	0.079	0.087		
E ⁽¹⁾	1.150	1.350	0.045	0.053		
E1	2.150	2.450	0.085	0.096		
e	0.650(BSC) ⁽²⁾	0.026(BSC) (2)			
e1	1.300(BSC) ⁽²⁾		0.051(BSC) ⁽²⁾		
L	0.260	0.460	0.010	0.018		
L1	0.5	525	0.021			
θ	0°	8°	0°	8°		

NOTE:

. 1. Plastic or metal protrusions of 0.15mm maximum per side are not included. 2. BSC (Basic Spacing between Centers), "Basic" spacing is nominal. 3. This drawing is subject to change without notice.



XDFN1.45X1-6⁽⁴⁾







Complete	Dimensions I	n Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
A ⁽¹⁾	0.500	0.600	0.020	0.024	
A1	0.000 0.050		0.000	0.002	
A2	0.150	REF ⁽²⁾	0.006 REF ⁽²⁾		
D ⁽¹⁾	1.400	1.500	0.055	0.059	
E ⁽¹⁾	0.950	1.050	0.037	0.041	
b	0.180	0.280	0.007	0.011	
е	0.500	BSC ⁽³⁾	0.020 BSC ⁽³⁾		
L	0.250	0.450	0.010	0.018	
L1	0.300	0.500	0.012	0.020	

NOTE:

- 1. Plastic or metal protrusions of 0.075mm maximum per side are not included.
- 2. REF is the abbreviation for Reference.
- 3. BSC (Basic Spacing between Centers), "Basic" spacing is nominal.
- 4. This drawing is subject to change without notice.



13 TAPE AND REEL INFORMATION

REEL DIMENSIONS

TAPE DIMENSION



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SOT23-6	7"	9.5	3.17	3.23	1.37	4.0	4.0	2.0	8.0	Q3
SC70-6	7"	9.5	2.40	2.50	1.20	4.0	4.0	2.0	8.0	Q3
XDFN1.45X1-6	7"	9.5	1.2	1.65	0.7	4.0	4.0	2.0	8.0	Q1

NOTE:

1. All dimensions are nominal.

2. Plastic or metal protrusions of 0.15mm maximum per side are not included.

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